

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

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HF0402A471R-10

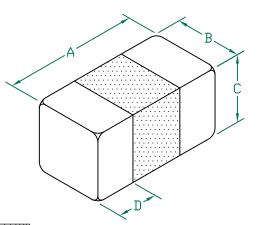
UNCONTROLLED DOCUMENT

PHYSICAL DIMENSIONS:

A 1.01 [.040] ± 0.18 [.007] B 0.50 [.020] ± 0.20 [.008]

0.50 [.020] ± 0.20 [.008]

D 0.30 [.012] MAX.

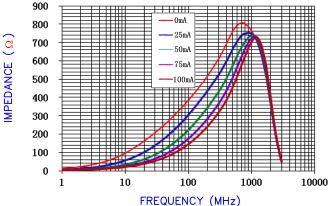


ELECTRICAL CHARACTERISTICS: Z@1000MHz Z@100MHz **DCR** RATED CURRENT (Ω) (Ω) (Ω) Nominal 1000 470 Minimum 600 353 Maximum 100mA 1400 588 1.0

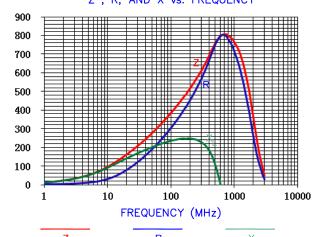
NOTES: UNLESS OTHERWISE SPECIFIED

- 1. TAPED AND REELED PER CURRENT EIA SPECIFICATIONS 7" REELS, 10K PCS/REEL, PAPER CARRIER TAPE
- 2. TERMINATION FINISH IS 100% TIN.
- 3. COMPONENTS SHOULD BE ADEQUATELY PREHEATED BEFORE SOLDERING.
- 4. OPERATING TEMPERATURE TEMP: -40° C~+125° C (INCLUDING SELF-HEATING)

Z vs FREQUENCY IMPEDANCE UNDER DC BIAS



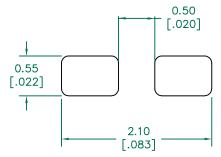




AGILENT E4991A RF Impedance/Material Analyzer
AGILENT 16194A Test Fixture.

IMPEDANCE (□)

LAND PATTERNS FOR REFLOW SOLDERING



(For wave soldering, add 0.763 (.030 to this dimension.)

RECOMMENDED SOLDERING CONDITIONS

